



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: TSILEVICH, Maoz Betzer

SERIAL NO.: 09/544,142

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EXAMINER: Anthony, J. D.

TITLE: ENDOTHERMIC HEAT SHIELD COMPOSITION AND METHOD FOR THE PREPARATION THEREOF

DATE OF MAILING OF  
NOTICE OF ALLOWANCE  
AND ISSUE FEE DUE: 08-12-05

ISSUE BATCH NO.:

TRANSMITTAL OF FORMAL DRAWINGS

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450  
Sir:

Attached please find one (1) sheet (Fig. 1) of more clear formal drawings of this application. Changes have been made in the drawings, which have already been accepted. They are replacement pages as indicated.

Respectfully submitted,

8-12-05  
Date

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CERTIFICATE OF MAILING UNDER 37 CFR 1.8(a)

I hereby certify that the attached FORMAL DRAWINGS are being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to:

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on 8-12, 2005.

8-12-05  
Date

John S. Egbert